


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	CRP/22/13680	
<b>1.3 Title of PCI</b>	NEW 12" WAFERS FAB (AG300) IN AGRATE AVAILABLE FOR PRODUCTION (EARLY NOTIFICATION)	
<b>1.4 Product Category</b>	see list	
<b>1.5 Issue date</b>	2022-09-29	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	ROBERTSON HEATHER
<b>2.1.2 Phone</b>	+1 8475853058
<b>2.1.3 Email</b>	heather.robertson@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Process Owner</b>	Delphine MAURY
<b>2.1.2 Corporate Quality Manager</b>	Gerard PETIT

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication	ST Crolles300 (Crolles / France) ST AG300 (Agrate / Italia)

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	ST Crolles300 (Crolles / France) Diffusion Plant	ST Crolles300 (Crolles / France) Diffusion Plant and ST AG300 (Agrate / Italia) Diffusion Plants
<b>4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?</b>	Form : no impact Fit : no impact Function : no impact Reliability : no impact Processability : no impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Expansion of current silicon diffusion capability to both provide additional capacity and additional sourcing flexibility
<b>5.2 Customer Benefit</b>	CAPACITY INCREASE

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	Dedicated Finished Good codes
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2023-04-28
<b>7.2 Intended start of delivery</b>	2023-05-31
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>			
<b>8.2 Qualification report and qualification results</b>	In progress	<b>Issue Date</b>	

**9. Attachments (additional documentations)**

13680 Public product.pdf  
13680 PCI AG300 FAB\_Early Notification\_rev3\_W39.pdf

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	IIS2DHTR	
	IIS2DLPCTR	
	ILPS22QSTR	
	LIS2DE12TR	
	LIS2DH12TR	
	LIS2DTW12TR	
	LIS2DW12TR	
	LIS3DHTR	
	LPS22DFTR	
	LPS28DFWTR	
	LSM303AGRTR	
	LSM6DSOQTR	
	LSM6DSOTR	
	LSM6DSOXTR	
	MIS2DHTR	



## Public Products List

Public Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

**PCI Title :** NEW 12" WAFERS FAB (AG300) IN AGRATE AVAILABLE FOR PRODUCTION (EARLY NOTIFICATION)

**PCI Reference :** CRP/22/13680

**Subject :** Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

LSM6DSOTR	LSM6DSOXTR	IIS2DLPCTR
LPS22DFTR	LSM6DSOPTR	LIS2DH12TR
LIS3DHTR	MIS2DHTR	LPS28DFWTR
LIS2DTW12TR	LSM303AGRTR	ILPS22QSTR
LSM6DSVTR	LIS2DE12TR	LIS2DW12TR
IIS2DHTR		



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